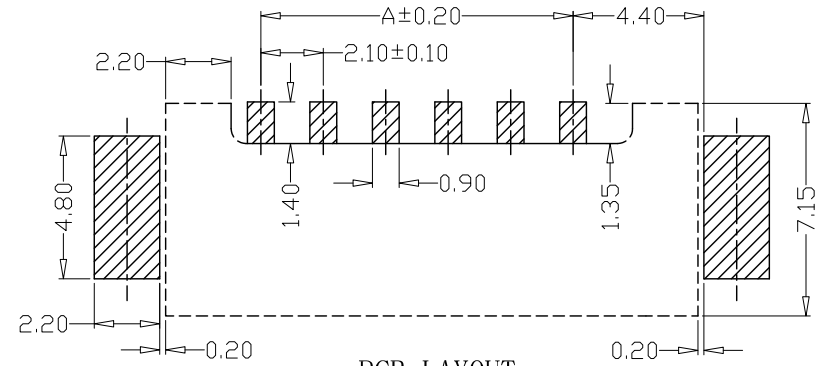
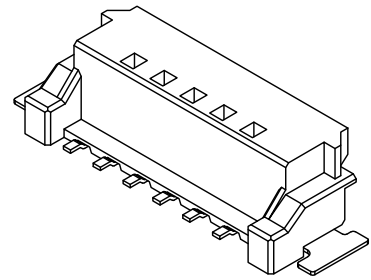
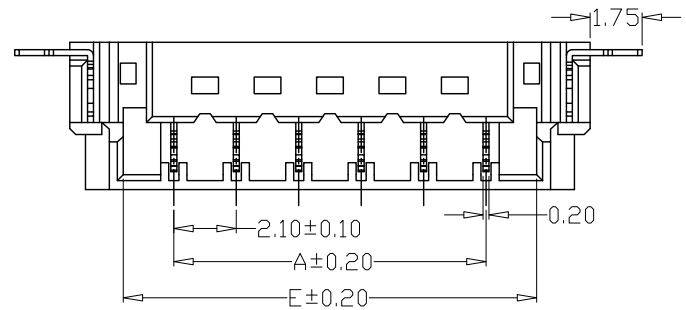
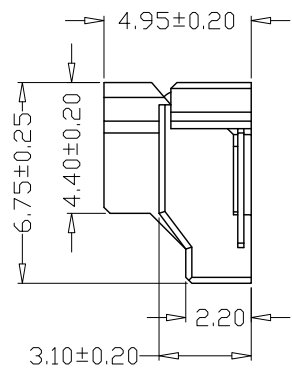
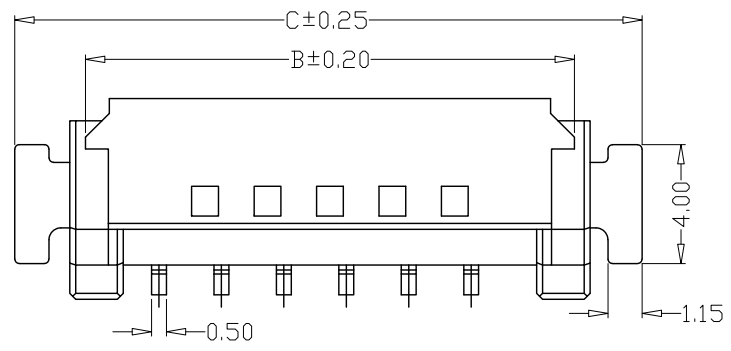


版本 REV.	日期 DATE	ECN NO.	变更内容 DESCRIPTION	制图 DRAWN

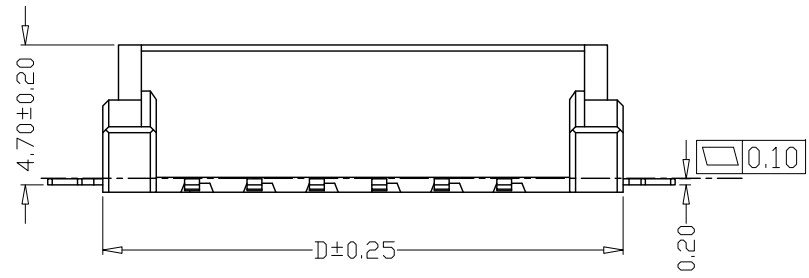


PCB LAYOUT



SPECIFICATIONS

- Current Rating: 1A AC, DC
- Voltage Rating: 300V AC, DC
- Temperatuer Range: -25°C~+85°C
- Contact Resistance: 30mΩ Max
- Insulation Resistance: 1000MΩ Min
- Withstanding Voltang: 1800V AC/minute
- Material: Wafer PA6T, Beige UL94V-0
PIN phosphor bronze Tin-plated
Solder Tab phosphor bronze Tin-plated



PIN	尺寸 (mm)				
	A	B	C	D	E
-06AWB	10.50	16.45	21.00	17.50	13.90
-10AWB	18.90	24.85	29.40	25.90	22.30

GENERAL TOLERANCE		制图 Mapping	张迎春 2022、09、13	料号 PART NO.	B21001-nAWB	版本 REV.	A
X±0.25	X°±2°	审核 Audit	钱岳生 2022、09、13	品名 TITLE	21001沉板式 WAFER SMT TYPE	页次 SHEET	1/1
.X±0.25	.X°±1°	核准 Approved	张名 2022、09、14	客户料号 CUTM. NO.			
.XX±0.15	.XX°±0.5°	单位 Units	MM	比例 SCALE	1:1		
.XXX±0.10	.XXX°±0.5°			 乐清市宏一电子有限公司 YueQing HongYi Electronics Co., Ltd			